VSP2101

CCD SIGNAL PROCESSOR
For Digital Cameras

FEATURES
- CCD SIGNAL PROCESSING:
  - Correlated Double Sampling
  - Black Level Clamping
  - –2 to +34dB Gain Ranging
  - High SNR: 53dB
- 10-BIT A/D CONVERSION:
  - Up to 27MHz Conversion Rate
  - No Missing Codes
- PORTABLE OPERATION:
  - Low Voltage: 2.7V to 3.6V
  - Low Power: 190mW at 3.0V
- LOW POWER: 160mW at 2.7V
- POWER-DOWN MODE: 18mW

DESCRIPTION
The VSP2101Y is a complete digital camera IC, providing signal conditioning and 10-bit analog-to-digital conversion for the output of a CCD array.

The primary CCD channel provides correlated double sampling to extract the video information from the pixels, –2dB to +34dB gain ranging with digital control for varying illumination conditions, and black level clamping for an accurate black reference.

Input signal clamping and offset correction of the CDS is also performed. The stable gain control is linear in dB. Additionally, the black level is quickly recovered after gain change. An on-chip general purpose 10-bit digital-to-analog converter allows you to obtain analog control voltage for iris control.

The VSP2101Y is available in a 48-lead LQFP package and operates from a single +3V supply.
### PACKAGING INFORMATION

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(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

** OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) **MSL, Peak Temp.** - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) **Lead/Ball Finish** - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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